



ULTRA PRECISION 8:1 MUX WITH INTERNAL TERMINATION AND 1:2 CML FANOUT BUFFER

Precision Edge™
SY58037U

FEATURES

- Selects between 1 of 8 inputs, and provides two precision, low skew CML output copies
- Guaranteed AC performance over temperature and voltage:
 - DC to 5Gbps throughput
 - <450ps propagation delay IN-to-Q ($V_{IN} \geq 300mV$)
 - <70ps t_r / t_f time
 - <15ps skew (output-to-output)
- Unique, patent-pending, channel-to-channel isolation design provides superior crosstalk performance
- Ultra-low jitter design:
 - <1ps_{rms} random jitter
 - <10ps_{pp} deterministic jitter
 - <10ps_{pp} total jitter (clock)
 - <0.7ps_{rms} crosstalk-induced jitter
- Unique, patent-pending, input termination and VT pin accepts DC- and AC-coupled inputs (CML, PECL, LVDS)
- 400mV CML output swing
- 50Ω source terminated outputs minimize round-trip reflections
- Power supply 2.5V ±5% or 3.3V ±10%
- -40°C to +85°C temperature range
- Available in 44-pin (7mm × 7mm) MLF™ package

APPLICATIONS

- Data communication systems
- All SONET/SDH data/clock applications
- All Fibre Channel applications
- All Gigabit Ethernet applications



Precision Edge™

DESCRIPTION

The SY58037U is a low jitter, low skew, high-speed 8:1 multiplexer with a 1:2 differential fanout buffer optimized for precision telecom and enterprise server distribution applications. The SY58037U distributes clock frequencies from DC to 4GHz and data rates to 5Gbps guaranteed over temperature and voltage.

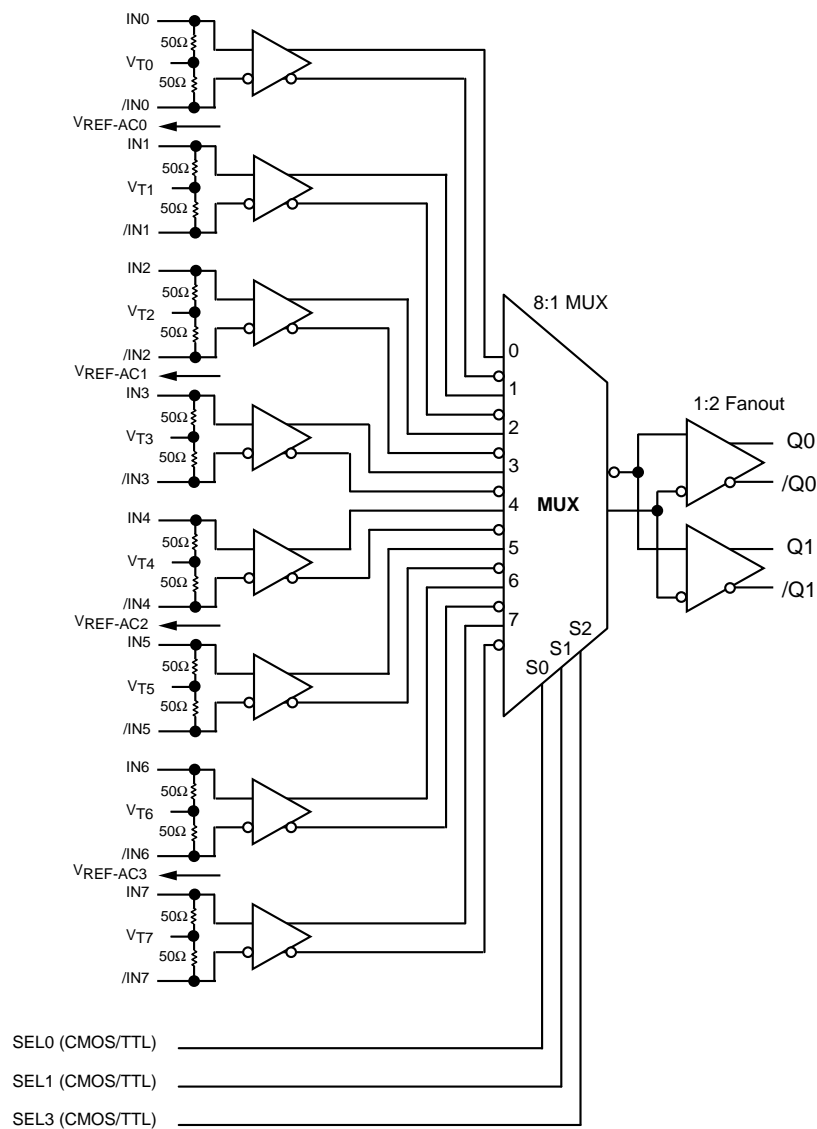
The SY58037U differential input includes Micrel's unique, 3-pin input termination architecture that directly interfaces to any differential signal (AC- or DC-coupled) as small as 100mV (200mVpp) without any level shifting or termination resistor networks in the signal path. The outputs are 50Ω source-terminated CML with extremely fast rise/fall time guaranteed to be less than 70ps.

The SY58037U features a patent-pending isolation design that significantly improves channel-to-channel crosstalk performance.

The SY58037U operates from a 2.5V ±5% or 3.3V ±10% supply and is guaranteed over the full industrial temperature range of -40°C to +85°C. The SY58037U is part of Micrel's high-speed, Precision Edge™ product line.

Data sheets and support documentation can be found on Micrel's web site at www.micrel.com.

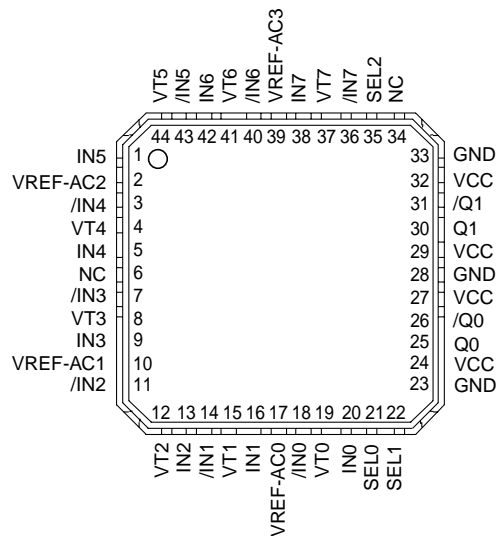
FUNCTIONAL BLOCK DIAGRAM



TRUTH TABLE

SEL2	SEL1	SEL0	Q	/Q
L	L	L	IN0	/IN0
L	L	H	IN1	/IN1
L	H	L	IN2	/IN2
L	H	H	IN3	/IN3
H	L	L	IN4	/IN4
H	L	H	IN5	/IN5
H	H	L	IN6	/IN6
H	H	H	IN7	/IN7

PACKAGE/ORDERING INFORMATION



44-Pin MLF™ (MLF-44)

Ordering Information⁽¹⁾

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY58037UMI	MLF-44	Industrial	SY58037U	Tn-Pb
SY58037UMITR ⁽²⁾	MLF-44	Industrial	SY58037U	Tn-Pb
SY58037UMI	MLF-44	Industrial	SY58037U and white dot or bar	Pb-Free
SY58037UMITR ⁽²⁾	MLF-44	Industrial	SY58037U and white dot or bar	Pb-Free

Notes:

1. Contact factory for die availability. Dice are guaranteed at $T_A = 25^\circ\text{C}$, DC electricals only.
2. Tape and Reel.

PIN DESCRIPTION

Pin Number	Pin Name	Pin Function
20, 18, 16, 14, 13, 11, 9, 7, 5, 3, 1, 43, 42, 40, 38, 36	IN0, /IN0, IN1, /IN1, IN2, /IN2, IN3, /IN3, IN4, /IN4, IN5, /IN5, IN6, /IN6, IN7, /IN7	Differential Inputs: These input pairs are the differential signal inputs to the device. Inputs accept AC or DC-coupled signals as small as 100mV. Each pin of a pair internally terminates to a VT pin through 50Ω. Note that these inputs will default to an indeterminate state if left open. Please refer to the "Input Interface Applications" section for more details.
19, 15, 12, 8, 4, 44, 41, 37	VT0, VT1 VT2, VT3, VT4, VT5, VT6, VT7	Input Termination Center-Tap: Each side of the differential input pair terminates to a VT pin. The VT pins provide a center-tap to a termination network for maximum interface flexibility. See "Input Interface Applications" section for more details.
17, 10, 2 39	VREF-AC0, VREF-AC1, VREF-AC2, VREF-AC3	Reference Voltage: This output biases to $V_{CC}-1.2\text{V}$. It is used when AC coupling the inputs (IN, /IN). For AC-coupled applications, connect VREF_AC to the VT pin and bypass with a 0.01μF low ESR capacitor to V_{CC} . See "Input Interface Applications" section for more details.
21, 22, 35	SEL0, SEL1, SEL2	The TTL/CMOS-compatible inputs select the inputs to the multiplexer. Note that this input is internally connected to a 25kΩ pull-up resistor and will default to a logic HIGH state if left open.
24, 27, 29, 32	VCC	Positive Power Supply. Bypass with 0.1μF 0.01μF low ESR capacitors as close to each VCC pin.
25, 26, 30, 31	Q0, /Q0, Q1, /Q1	Differential Outputs: These CML output pairs are the outputs of the device. Please refer to the truth table below for details. Unused output pairs may be left open. Each output is designed to drive 400mV into 100Ω across each output pair.
23, 28, 33	GND, Exposed Pad	Ground. GND and exposed pad must both be connected to the most negative potential of chip ground.

Absolute Maximum Ratings⁽¹⁾

Power Supply Voltage (V_{CC})	–0.5V to +4.0V
Input Voltage (V_{IN})	–0.5V to V_{CC}
LVPECL Output Current (I_{OUT})	
Continuous	50mA
Surge	100mA
Termination Current ⁽³⁾	
Source or sink current on VT pin	±100mA
Lead Temperature (soldering, 10 sec.)	265°C
Storage Temperature Range (T_S)	–65°C to +150°C

Operating Ratings⁽²⁾

Power Supply Voltage (V_{CC})	+2.375V to +2.625V
	+3.0V to +3.6V
Ambient Temperature Range (T_A)	–40°C to +85°C
Package Thermal Resistance ⁽⁴⁾	
MLF™ (θ_{JA})	
Still-Air	24°C/W
MLF™ (Ψ_{JB})	
Junction-to-board	12°C/W

DC ELECTRICAL CHARACTERISTICS⁽⁵⁾

T_A = –40°C to +85°C, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{CC}	Power Supply Voltage	$V_{CC} = 2.5V$.	2.375	2.5	2.625	V
		$V_{CC} = 3.3V$.	3.0	3.3	3.6	V
I_{CC}	Power Supply Current	No load, max. V_{CC} .		145	200	mA
R_{IN}	Input Resistance (IN-to- V_T)		40	50	60	Ω
R_{DIFF_IN}	Differential Input Resistance (IN-to-/IN)		80	100	120	Ω
V_{IH}	Input HIGH Voltage (IN-to-/IN)	Note 6	$V_{CC}-1.6$		V_{CC}	V
V_{IL}	Input LOW Voltage (IN-to-/IN)		0		$V_{IH}-0.1$	V
V_{IN}	Input Voltage Swing (IN-to-/IN)	See Figure 1a.	0.1		1.7	V
V_{DIFF_IN}	Differential Input Voltage Swing (IN-to-/IN)	See Figure 1b.	0.2			V
V_{T_IN}	IN to V_T (IN-to-/IN)				1.28	V
V_{REF_AC}	Output Reference Voltage		$V_{CC}-1.3$	$V_{CC}-1.2$	$V_{CC}-1.1$	V

Notes:

1. Permanent device damage may occur if ratings in the “Absolute Maximum Ratings” section are exceeded. This is a stress rating only and functional operation is not implied for conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Due to the limited drive capability, use for input of the same package only.
4. Package thermal resistance assumes exposed pad is soldered (or equivalent) to the device's most negative potential on the PCB. Ψ_{JB} uses 4-layer θ_{JA} in still-air number unless otherwise stated.
5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
6. V_{IH} (min), not lower than 1.2V.

CML OUTPUT DC ELECTRICAL CHARACTERISTICS⁽⁷⁾

$V_{CC} = 2.5V \pm 5\%$ or $3.3V \pm 10\%$; $T_A = -40^\circ C$ to $+85^\circ C$; $R_L = 100\Omega$ across each output pair, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{OH}	Output HIGH Voltage Q, /Q		$V_{CC}-0.040$	$V_{CC}-0.010$	V_{CC}	V
V_{OUT}	Output Differential Swing Q, /Q	See Figure 1a.	325	400		mV
V_{DIFF_OUT}	Differential Output Voltage Swing Q, /Q	See Figure 1b.	650	800		mV
R_{OUT}	Output Source Impedance		40	50	60	Ω

LVTTL/CMOS DC ELECTRICAL CHARACTERISTICS⁽⁷⁾

$V_{CC} = 2.5V \pm 5\%$ or $3.3V \pm 10\%$; $T_A = -40^\circ C$ to $+85^\circ C$, unless otherwise stated.

Symbol	Parameter	Condition	Min	Typ	Max	Units
V_{IH}	Input HIGH Voltage		2.0		V_{CC}	V
V_{IL}	Input LOW Voltage				0.8	V
I_{IH}	Input HIGH Current		-125		30	μA
I_{IL}	Input LOW Current		-300			μA

Note:

7. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

AC ELECTRICAL CHARACTERISTICS⁽⁸⁾

$V_{CC} = 2.5V \pm 5\%$ or $3.3V \pm 10\%$; $T_A = -40^\circ C$ to $+85^\circ C$, $R_L = 100\Omega$ across each output pair or equivalent, unless otherwise stated.

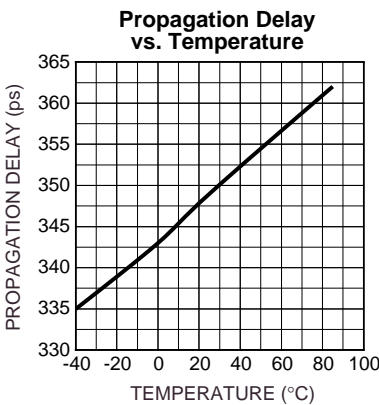
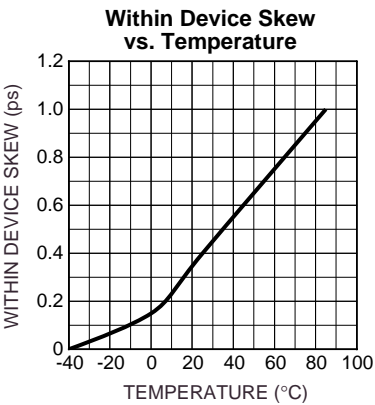
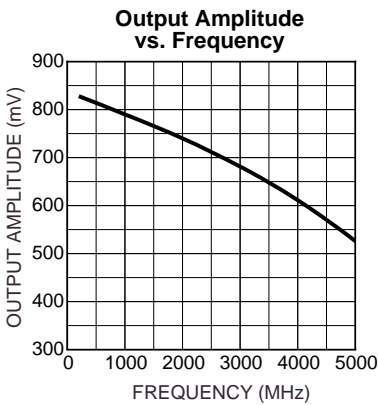
Symbol	Parameter	Condition	Min	Typ	Max	Units
f_{MAX}	Maximum Operating Frequency	NRZ data Clock	5 4			Gbps GHz
t_{pd}	Differential Propagation Delay (IN-to-Q)	$V_{IN} \geq 100mV$	240	35550	450	ps
	(SEL-to-Q)		100		550	ps
$\Delta t_{pd} \text{ Tempco}$	Differential Propagation Delay Temperature Coefficient			215		fs/ $^\circ C$
t_{SKEW}	Output-to-Output Skew	Note 9			15	ps
	Part-to-Part Skew	Note 10			150	ps
t_{JITTER}	Data Random Jitter (RJ)	Note 11			1	ps _{rms}
	Deterministic Jitter (DJ)	Note 12			10	ps _{pp}
	Clock Cycle-to-Cycle Jitter	Note 13			1	ps _{rms}
	Total Jitter (TJ)	Note 14			10	ps _{pp}
	Crosstalk-induced Jitter	Note 15			0.7	ps _{rms}
t_r, t_f	Output Rise/Fall Time	At full output swing, 20% to 80%.	20	40	70	ps

Notes:

8. High-frequency AC-parameters are guaranteed by design and characterization.
9. Output-to-output skew is measured between two different outputs under identical input transitions.
10. Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and with no skew of the edges at the respective inputs
11. Random jitter is measured with a K28.7 character pattern, measured at $\leq f_{MAX}$.
12. Deterministic jitter is measured at 2.5Gbps/3.2Gbps, with both K28.5 and $2^{23}-1$ PRBS pattern.
13. Cycle-to-cycle jitter definition: the variation of periods between adjacent cycles, $T_n - T_{n-1}$ where T is the time between rising edges of the output signal.
14. Total jitter definition: with an ideal clock input of frequency $\leq f_{MAX}$, no more than one output edge in 10^{12} output edges will deviate by more than the specified peak-to-peak jitter value.
15. Crosstalk is measured at the output while applying two similar differential clock frequencies that are asynchronous with respect to each other adjacent inputs.

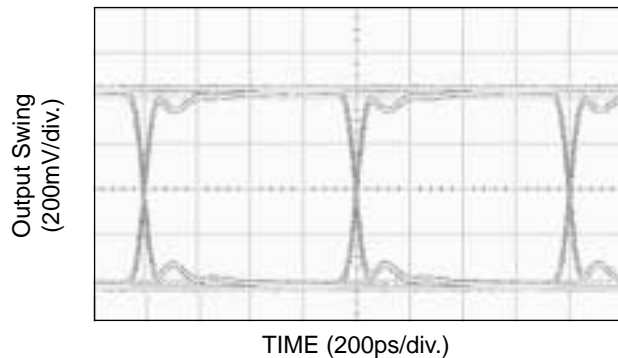
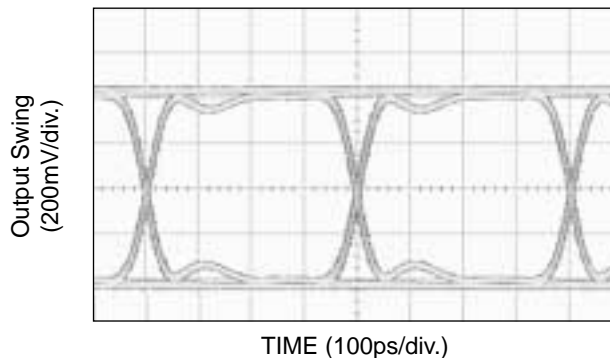
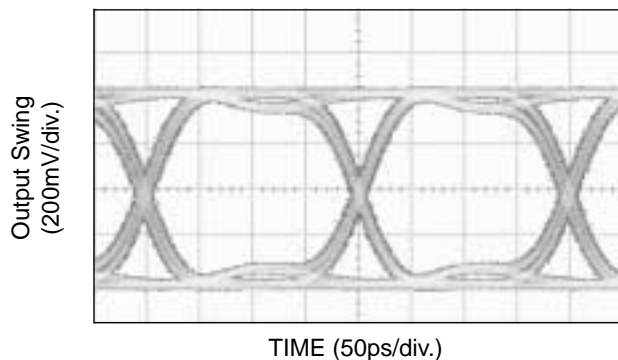
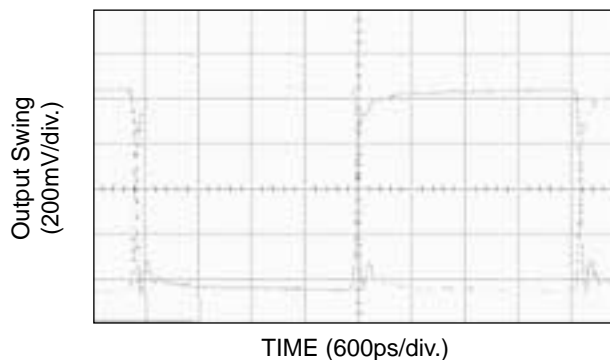
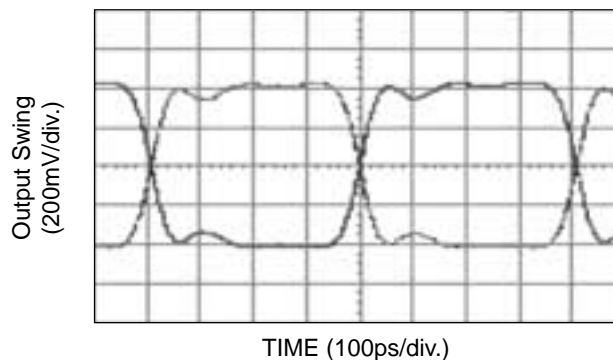
TYPICAL OPERATING CHARACTERISTICS

V_{CC} = 3.3V, GND = 0, V_{IN} = 100mV, T_A = 25°C, unless otherwise stated.



FUNCTIONAL CHARACTERISTICS

$V_{CC} = 3.3V$, $GND = 0$, $V_{IN} = 100mV$, $T_A = 25^\circ C$, unless otherwise stated.

1.25Gbps Output (Q – /Q)**2.5Gbps Output (Q – /Q)****5Gbps Output (Q – /Q)****200MHz Output (Q – /Q)****622MHz Output (Q – /Q)**

SINGLE-ENDED AND DIFFERENTIAL SWINGS

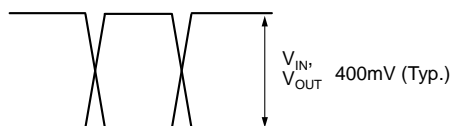


Figure 1a. Single-Ended Voltage Swing

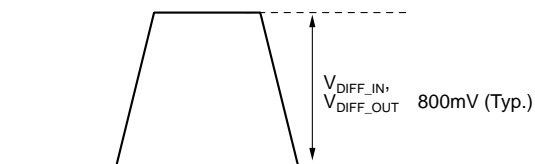


Figure 1b. Differential Voltage Swing

INPUT AND OUTPUT STAGES

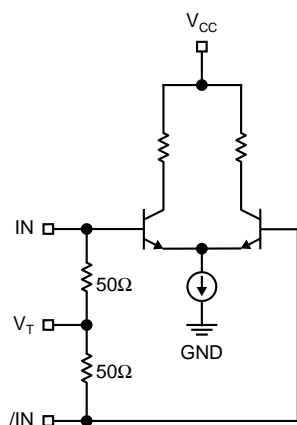


Figure 2a. Simplified Differential Input Stage

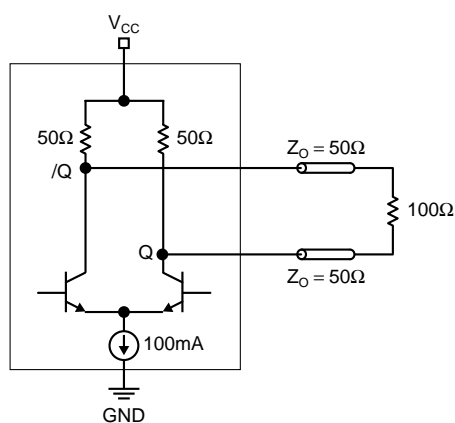


Figure 2b. CML DC-Coupled (100Ω Termination)

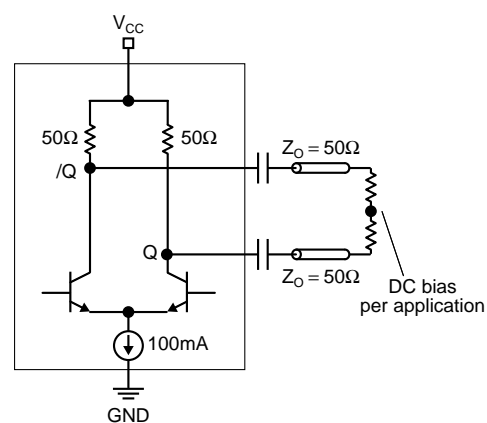


Figure 2c. CML AC-Coupled (50Ω Termination)

INPUT INTERFACE APPLICATIONS

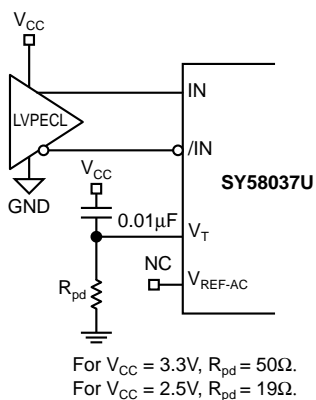


Figure 3a. LVPECL Interface (DC-Coupled)

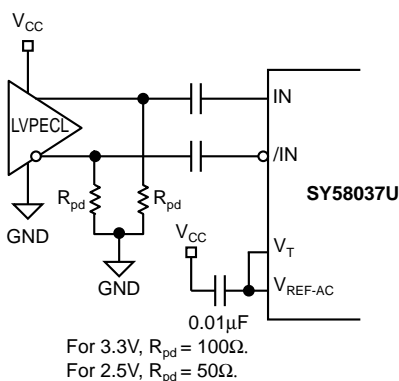


Figure 3b. LVPECL Interface (AC-Coupled)

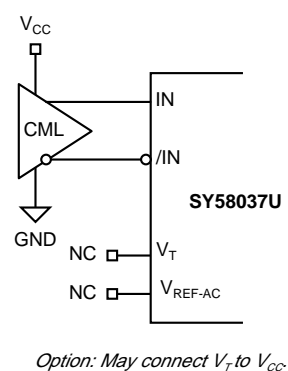


Figure 3c. CML Interface (DC-Coupled)

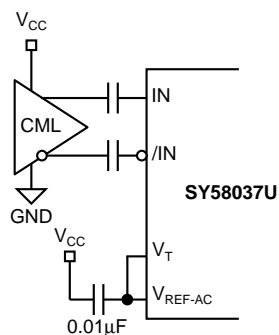


Figure 3d. CML Interface (AC-Coupled)

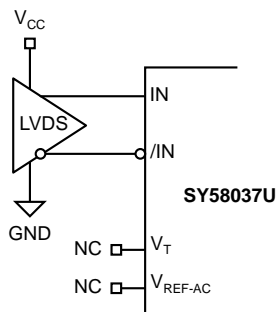
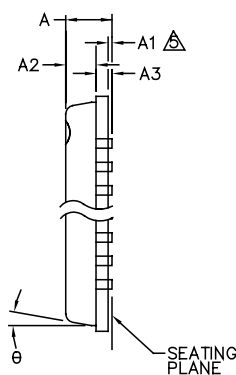
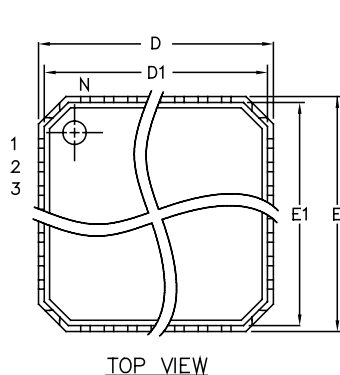


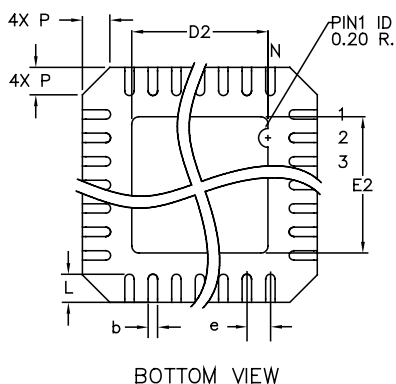
Figure 3e. LVDS Interface

RELATED MICREL PRODUCTS AND SUPPORT DOCUMENTATION

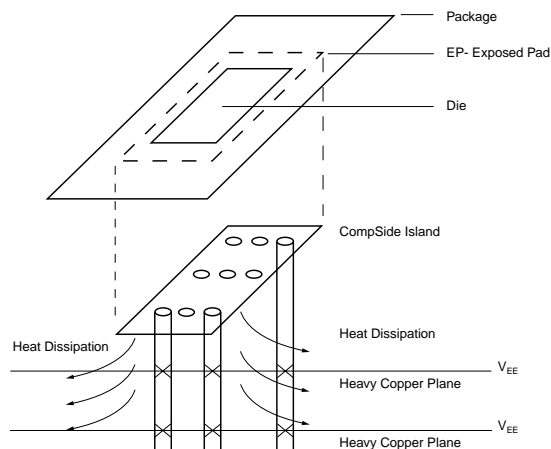
Part Number	Function	Data Sheet Link
SY58037U	Ultra Precision 8:1 MUX with Internal Termination and 1:2 CML Fanout Buffer	http://www.micrel.com/product-info/products/sy58037u.shtml
SY58038U	Ultra Precision 8:1 MUX with Internal Termination and 1:2 LVPECL Fanout Buffer	http://www.micrel.com/product-info/products/sy58038u.shtml
SY58039U	Ultra Precision 8:1 MUX with Internal Termination and 1:2 400mV LVPECL Fanout Buffer	http://www.micrel.com/product-info/products/sy58039u.shtml
	MLF™ Application Note	www.amkor.com/products/notes_papers/MLF_AppNote_0902.pdf
HBW Solutions	New Products and Applications	www.micrel.com/product-info/products/solutions.shtml

44 LEAD MicroLeadFrame™ (MLF-44)

	DIMENSION (mm)		
	MIN.	NOM.	MAX.
A	—	0.85	0.90
A1	0.00	0.01	0.05
A2	—	0.65	0.70
A3	0.20 REF.		
D	7.00 BSC		
D1	6.75 BSC		
D2	3.15	3.30	3.45
E	7.00 BSC		
E1	6.75 BSC		
E2	3.15	3.30	3.45
θ	12°		
P	0.24	0.42	0.60
e	0.50 BSC		
N	44		
L	0.50	0.60	0.75
b	0.18	0.23	0.30



- NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
 2. N IS THE NUMBER OF TERMINALS.
THE NUMBER OF TERMINALS PER SIDE IS N/4.
 3. THE PIN#1 IDENTIFIER MUST BE EXISTED ON THE TOP SURFACE OF PACKAGE BY USING IDENTIFICATION MARK OR OTHER FEATURE OF PACKAGE BODY.
 4. PACKAGE WARPAGE MAX 0.05mm.
- △ APPLIED FOR EXPOSED PAD AND TERMINALS.



PCB Thermal Consideration for 44-Pin MLF™ Package
(Always solder, or equivalent, the exposed pad to the PCB)

Package Notes:

1. Package meets Level 2 qualification.
2. All parts are dry-packaged before shipment.
3. Exposed pads must be soldered to a ground for proper thermal management.

MICREL, INC. 1849 FORTUNE DRIVE SAN JOSE, CA 95131 USA

TEL + 1 (408) 944-0800 FAX + 1 (408) 474-1000 WEB <http://www.micrel.com>

The information furnished by Micrel in this data sheet is believed to be accurate and reliable. However, no responsibility is assumed by Micrel for its use. Micrel reserves the right to change circuitry and specifications at any time without notification to the customer.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is at Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.